

VT-4B7

UL Approval: E214381 Version: 23/08/2023

**Metal Base Laminate** 

#### **General Information**

- > Thermal conductivity -- 7.0 W/mK
- > Ceramic Filled
- > Halogen Free
- > Flammability UL94 V-0
- > MOT 130°C

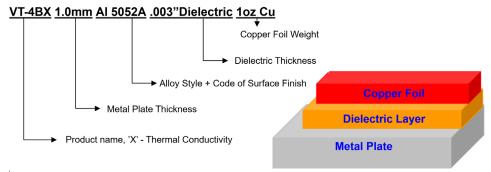
# **Application**

- > Super Bright Lighting
- > Power Conversion
- > Controllers
- > Motor Drives
- > Rectifiers
- > Power Supply

### **Storage Condition**

		Laminate
Storage Condition	Temperature	Room
	Relative humidity	/

# **Designation of IMS Laminate**





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# **Laminate Properties**

ltem		Test Method (IPC-TM-650)	Unit	Dielectric Thickness		
				75µm	100µm	150µm
Thermal Conductivity		IS022007-2	W/m*K			
Thermal Impedance		IS022007-2	°C*in2/W	0.017	0.022	0.034
	DSC	2.4.25	οС	100		
Tg	DMA	2.4.24.4	٥		145	
Td	TGA	ASTM D3850	°C	380		
Thermal Stress	Solder Dip @ 288°C	2.4.13.1	Minute	≥5		
Hi-Pot Withstand	DC	2.5.7.2	V	>600		
Breakdown Voltage	AC	2.5.6.3	V	7000	8000	10000
Dk @ 1MHz	C-24/23/50	2.5.5.3	_		4.8	
Df @ 1MHz	C-24/23/50	2.5.5.3	_		0.016	
Volume Resistance	After Moisture	2.5.17.1	MΩ-cm		5.0E+8	
	E-24/125				3.0E+7	
	After Moisture	0.5.45.4	MO		2.0E+7	
Surface Resistance	E-24/125	2.5.17.1	ΜΩ		5.0E+6	
Peel strength (1oz)	As Received	2.4.8	Lb/in	4.5		
СТІ	As Received	ASTM D3638	V		600	
Flammability	As Received	UL 94	Rating		V-0	
RTI	Electric	UL 746E	°C	130		
	Mechanical	UL 746E	oC		130	

<sup>(1)</sup> All test data provided are typical values and not intended to be specification values.

<sup>(2)</sup> Hi-Pot proof test (600VDC) is performed 100% on the whole working panels (with copper foil). Any higher requirement of Hi-Pot test can be AABUS.

<sup>(3)</sup> Breakdown test is a destructive test, which is done on substrate (without copper foil) of a random sample in the FQC laboratory. Disclaimer: The information and data contained in this technical literature is based on data and knowledge correct at the time of publishing/printing and is believed to be accurate and is offered in good faith for the benefit of the user. The user should make his own tests to verify the suitability of this product for any application before its use. All data are typical values only and subject to change without notice.



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# Metal Base Laminate

# **Availability**

### **Metal Plate Selection**

Item		Thermal Conductivity (W/mK)	Hardness (HV)	Tensile Strength (MPa)	Density (g/cm³)	CTE (ppm/°C)	Standard Thickness (mm)
Aluminum (Al)	5052H32	138	68	215	2.7	23.8	1.0, 1.5, 2.0, 3.0
	6061T6	167	95	276	2.7	23.6	1.0, 1.5, 2.0
	CTE II	170	45	189	2.7	19	1.0, 1.5, 2.0
Copper (Cu)	C1100	386	95	310	8.9	16.8	1.0, 1.5, 2.0

Remark: Additional thicknesses could be available upon request.

### Laminate

Item		Availability
Dielectric Thickness		.003" (75μm), .004" (100μm), .006" (150μm)
Standard Size	Imperial (inch)	18.11*24.02, 20.08*24.02, 20.98*24.02
	Metric (mm)	460*610, 510*610, 533*610
Copper Weight		Hoz, 1oz, 2oz, 3oz, 4oz, 5oz, 6oz

Remark: Additional options could be possible upon request.

#### Surface Finish for Aluminum Plate

Code	Surface Finish
None	Default Brushing
"A"	Anodizing
"ER I"	High Emissivity

### **Protective Film for Metal Plate**

Туре	Material	Max Operation Temperature
Standard	PET	170 °C
High Temperature	Polyimide	270 °C